Vishay Siliconix



HVMDIP

PRODUCT SUMMARY

V_{DS} (V)

R_{DS(on)} (Ω)

Q_{qs} (nC)

Q_{ad} (nC)

Qg (Max.) (nC)

Configuration

Power MOSFET

s

N-Channel MOSFET

0.27

100

16

4.4

7.7

Single

 $V_{GS} = 10 V$

FEATURES

- Dynamic dV/dt rating
- Repetitive avalanche rated
- For automatic insertion
- End stackable
- 175 °C operating temperature
- Fast switching
- Ease of paralleling
- Material categorization: for definitions of compliance please see <u>www.vishay.com/doc?99912</u>

DESCRIPTION

Third generation power MOSFETs from Vishay provide the designer with the best combination of fast switching, ruggedized device design, low on-resistance and cost-effectiveness.

The 4 pin DIP package is a low cost machine-insertable case style which can be stacked in multiple combinations on standard 0.1" pin centers. The dual drain serves as a thermal link to the mounting surface for power dissipation levels up to 1 W.

ORDERING INFORMATION	
Package	HVMDIP
Lead (Pb)-free	IRFD123PbF

ABSOLUTE MAXIMUM RATINGS ($T_A = 25 \text{ °C}$, unless otherwise PARAMETER			SYMBOL	LIMIT	UNIT	
Drain-source voltage			V _{DS}	100		
Gate-source voltage			V _{GS}	± 20	V	
Continuous drain current	V at 10 V	T _A = 25 °C T _A = 100 °C	1	1.3	А	
Continuous drain current	V _{GS} at 10 V	T _A = 100 °C	I _D	0.94		
Pulsed drain current ^a			I _{DM}	10	1	
Linear derating factor				0.0083	W/°C	
Single pulse avalanche energy ^b			E _{AS}	100	mJ	
Repetitive avalanche current ^a			I _{AR}	1.3	А	
Repetitive avalanche energy ^a			E _{AR}	0.13	mJ	
Maximum power dissipation $T_A = 25 \text{ °C}$			PD	1.3	W	
Peak diode recovery dV/dt ^c			dV/dt	5.5	V/ns	
Operating junction and storage temperature range			T _J , T _{stg}	-55 to +175	°C	
Soldering recommendations (peak temperature) For 10 s			300 ^d			

Notes

- a. Repetitive rating; pulse width limited by maximum junction temperature (see fig. 11)
- b. V_{DD} = 25 V, starting T_J = 25 °C, L = 22 mH, R_g = 25 Ω , I_{AS} = 2.6 A (see fig. 12)
- c. $I_{SD} \le 9.2$ A, dl/dt ≤ 110 A/µs, $V_{DD} \le V_{DS}$, $T_J \le 175$ °C
- d. 1.6 mm from case

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COMPLIANT



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THERMAL RESISTANCE RATINGS				
PARAMETER	SYMBOL	TYP.	MAX.	UNIT
Maximum Junction-to-Ambient	R _{thJA}	-	120	°C/W

PARAMETER	SYMBOL	TEST CONDITIONS MIN. TYP.		MAX.	UNIT		
Static		<u>.</u>					•
Drain-Source Breakdown Voltage	V _{DS}	$V_{GS} = 0 \text{ V}, \text{ I}_{D} = 250 \mu\text{A}$		100	-	-	V
V _{DS} Temperature Coefficient	$\Delta V_{DS}/T_J$	Referen	ce to 25 °C, I _D = 1 mA	-	0.13	-	V/°C
Gate-Source Threshold Voltage	V _{GS(th)}	V _{DS}	= V _{GS} , I _D = 250 μΑ	2.0	-	4.0	V
Gate-Source Leakage	I _{GSS}		V _{GS} = ± 20 V	-	-	± 100	nA
		V _{DS}	$V_{DS} = 100 \text{ V}, \text{ V}_{GS} = 0 \text{ V}$		-	25	
Zero Gate Voltage Drain Current	I _{DSS}	V _{DS} = 80 V	′, V _{GS} = 0 V, T _J = 150 °C	-	-	250	μA
Drain-Source On-State Resistance	R _{DS(on)}	V _{GS} = 10 V	I _D = 0.78 A ^b	-	-	0.27	Ω
Forward Transconductance	g _{fs}			S			
Dynamic		-					I
Input Capacitance	C _{iss}		$V_{GS} = 0 V$ $V_{DS} = 25 V$		360	-	pF
Output Capacitance	C _{oss}				150	-	
Reverse Transfer Capacitance	C _{rss}	f = 1	0 MHz, see fig. 5	-	34	-	
Total Gate Charge	Qg			-	-	16	
Gate-Source Charge	Q_gs	V _{GS} = 10 V	$I_D = 9.2 \text{ A}, V_{DS} = 80 \text{ V}$ see fig. 6 and 13 ^b	-	-	4.4	nC
Gate-Drain Charge	Q _{gd}	see fig. 6 and 135		-	7.7	1	
Turn-On Delay Time	t _{d(on)}			-	6.8	-	
Rise Time	t _r	Vaa	= 50 V, I _D = 9.2 A	-	27	-	
Turn-Off Delay Time	t _{d(off)}		$R_{\rm D} = 5.2 \ \Omega$, see fig. 10 ^b	-	18	-	ns
Fall Time	t _f			-	17	-	
Internal Drain Inductance	L _D	6 mm (0.25")	Between lead, 6 mm (0.25") from		4.0	-	
Internal Source Inductance	L _S	 package and die contact 	center of	-	6.0	-	nH
Drain-Source Body Diode Characteristic	s	<u>.</u>			•		•
Continuous Source-Drain Diode Current	I _S	MOSFET symbol showing the		-	-	1.3	Α
Pulsed Diode Forward Current ^a	I _{SM}	integral revers p - n junction		-	-	10	A
Body Diode Voltage	V_{SD}	T _J = 25 °C	, I _S = 1.3 A, V _{GS} = 0 V ^b	-	-	2.5	V
Body Diode Reverse Recovery Time	t _{rr}	T 05 00 1	0.0.4 JU/JU 400.4/ b	-	130	260	ns
Body Diode Reverse Recovery Charge	Q _{rr}	Τ _{.I} = 25 °C, I _F = 9.2 A, dl/dt = 100 A/μs ^b		1.3	μC		
Forward Turn-On Time	t _{on}	Intrinsic tu	rn-on time is negligible (turn	-on is dor	ninated b	y L _S and	L _D)

Notes

a. Repetitive rating; pulse width limited by maximum junction temperature (see fig. 11)

b. Pulse width \leq 300 µs; duty cycle \leq 2 %

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TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

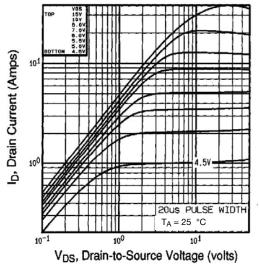


Fig. 1 - Typical Output Characteristics, T_A = 25 °C

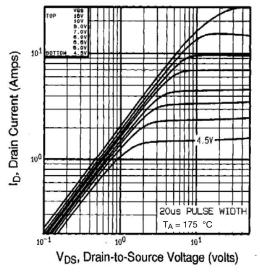
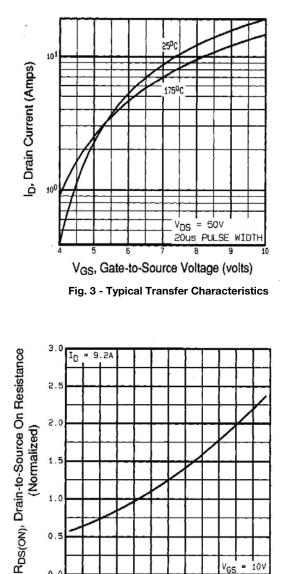


Fig. 2 - Typical Output Characteristics, T_A = 175 $^\circ C$



 $0.0_{-60-40-20}$ 0 20 40 50 80 100 120 140 150 180 T_J, Junction Temperature (°C)

Fig. 4 - Normalized On-Resistance vs. Temperature

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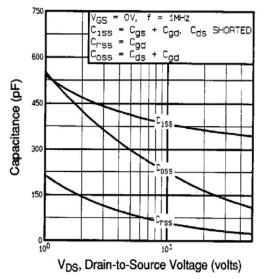


Fig. 5 - Typical Capacitance vs. Drain-to-Source Voltage

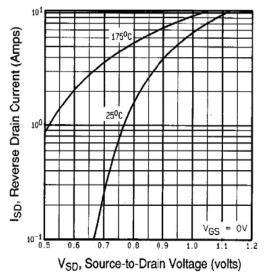


Fig. 7 - Typical Source-Drain Diode Forward Voltage

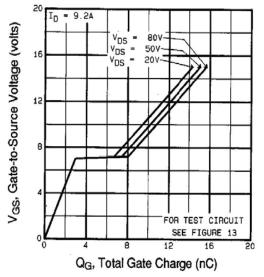
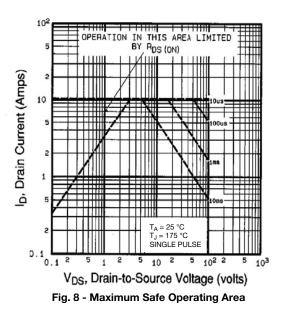


Fig. 6 - Typical Gate Charge vs. Gate-to-Source Voltage



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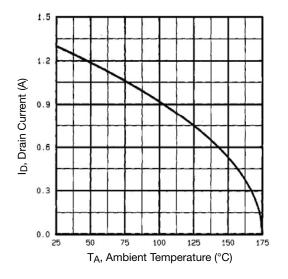


Fig. 9 - Maximum Drain Current vs. Ambient Temperature

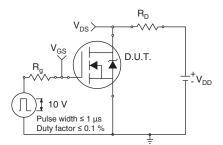


Fig. 10a - Switching Time Test Circuit

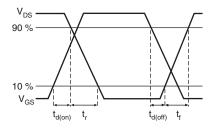


Fig. 10b - Switching Time Waveforms

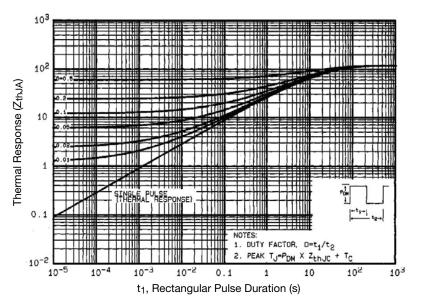


Fig. 11 - Maximum Effective Transient Thermal Impedance, Junction-to-Ambient

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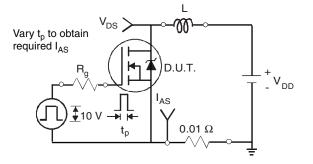


Fig. 12a - Unclamped Inductive Test Circuit

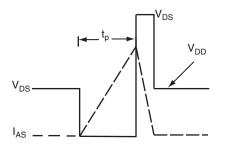


Fig. 12b - Unclamped Inductive Waveforms

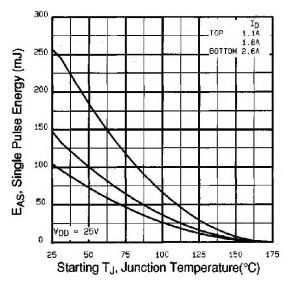
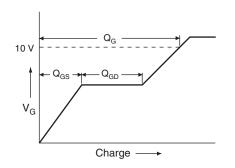


Fig. 12c - Maximum Avalanche Energy vs. Drain Current





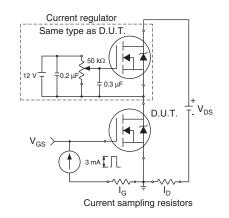


Fig. 13b - Gate Charge Test Circuit

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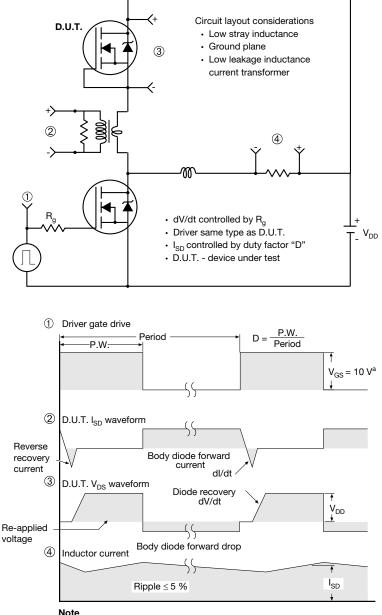
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Peak Diode Recovery dV/dt Test Circuit



a. V_{GS} = 5 V for logic level devices

Fig. 14 - For N-Channel

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HVM DIP (High voltage)





	INCHES		MILLIN	IETERS
DIM.	MIN.	MAX.	MIN.	MAX.
А	0.310	0.330	7.87	8.38
E	0.300	0.425	7.62	10.79
L	0.270	0.290	6.86	7.36
ECN: X10-0386-Rev. B, 0 DWG: 5974	06-Sep-10			

Note

1. Package length does not include mold flash, protrusions or gate burrs. Package width does not include interlead flash or protrusions.



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